



ABSTRACT

This user's guide describes the TPS25854-Q1 evaluation module (TPS25854Q1EVM-164). This document contains the EVM schematics, EVM configuration, bill of materials (BOM), board layout drawing, and assembly drawing.

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Trademarks

USB Type-C® is a registered trademark of USB Implementers Forum.
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1 Introduction

The TPS25854Q1EVM-164 is an evaluation module (EVM) for TI's TPS25854-Q1 USB Type-C® and BC1.2 dual Type-C ports which is capable of providing up to 3-A output current, 3 A for each port with cable compensation. The EVM operates over a range from 5.5 V to 26 V and withstands 40-V transient voltage. The value of cable compensation, current limit, output voltage and switching frequency can be adjusted by resistors on the EVM.

1.1 Features

The following features are available on this EVM:

- 5.5-V to 26-V input range, 3-A continuous output current buck converter for each port
- 200-mA capability for OUT pin, 200-mA capability for VCONN power meeting for USB3.1 power requirement
- Forced PWM operation with Spread-Spectrum Dithering
- Fully AEC-Q100 qualified
- Programmable output current limit: $\pm 10\%$ accuracy at 3.4 A
- Smart thermal management
- USB battery charging specification Rev. 1.2 DCP mode, divider3 mode, Samsung 1.2-V mode, and USB Type-C Rev. 1.3 compliant
- User-programmable VBUS current limit and internal VCONN current limiting

1.2 Applications

The EVM is used in the following applications:

- Automotive: USB media hubs, USB charging ports, aftermarket Dual USB chargers

2 Schematic

Figure 2-1 illustrates the TPS25854Q1EVM-164 schematic.

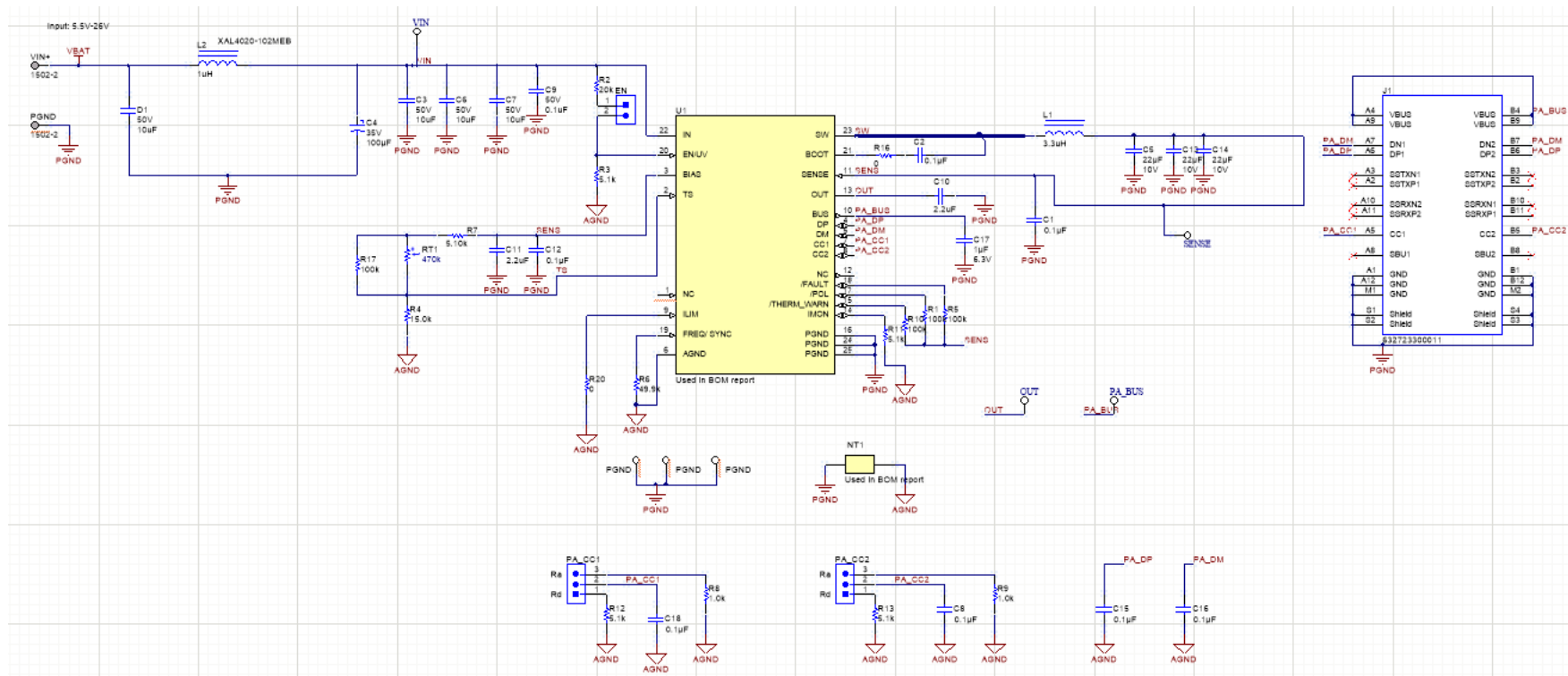


Figure 2-1. TPS25854Q1EVM-164 Schematic

3 General Configuration and Description

This section describes the connectors, jumpers, and test points on the EVM and how to properly connect, set up, and use the TPS25854Q1EVM-164.

3.1 Physical Access

[Table 3-1](#) lists the TPS25854Q1EVM-164 connector functionality, [Table 3-2](#) describes the jumper configuration, and [Table 3-3](#) describes the test point availability.

Table 3-1. Connectors

Connector	Component Type	Description
J1	USB Type-C connector, receptacle	Downstream facing USB Type-C connector. Connect to the USB Type-C slave for data pass through from PA/B_CC1/2 and BC1.2 or USB Type-C identification. USB output power is provided to the slave from the buck converter of the TPS25854-Q1 device.
VIN+, PGND	Terminal block	Power input connector for TPS25854-Q1. Connect to a 5.5-V to 26-V power supply.

Table 3-2. Jumper

Jumper	Label	Description
PA_CC1	PA_CC1	3 × 1 header. Install shunt to connect Ra or Rd on CC1 of port-A. Remove shunt to float CC1.
PA_CC2	PA_CC2	3 × 1 header. Install shunt to connect Ra or Rd on CC2 of port-A. Remove shunt to float CC2.

Table 3-3. Test Points

Test Point	Label	Description
VIN	VIN	VIN pin test point
EN	EN	EN pin test point
OUT	OUT	OUT pin test point
SENSE	SENSE	SENSE pin test point
PA_BUS	PA_BUS	BUS pin of Port A test point
PGND	PGND	Power ground pin test point

3.2 Adjusting the Switching Frequency

If other frequencies are desired, within the frequency range of 200 kHz to 3 MHz, the RFREQ (R6) resistor value can be changed. Consult the data sheet for proper selection of the RFREQ resistor. Change the inductor (L1) and the total output capacitance for proper control-loop operation. The FREQ/SYNC pin can also be used to synchronize the internal oscillator to an external clock. The TPS25850EVMQ1-088 allows users to synchronize the internal oscillator to both Lo-Z clock source and Hi-Z clock source. See the data sheet for detailed information.

3.3 Adjusting the Current Limit Value

If other current limit values are desired, the RILIM resistor value can be changed. Modifying the value of R20 can change current limit threshold. Consult the data sheet for proper selection of RILIM.

3.4 Adjusting the Cable Compensation Value

For TPS25854-Q1, set with IMON, the buck regulator will increase its output voltage linearly as the load current increases, and the maximum voltage compensation is 400mV.

3.5 Thermal Management

The TS input pin allows for user programmable thermal protection. See Electrical Characteristics for TS pin thresholds. The TS input pin threshold is ratio metric with VSENSE. The external resistor divider setting VTS (R4, R7, and R17) must be connected to the TPS2585x-Q1 SENSE pin to achieve accurate results. See the data sheet for detailed information.

3.6 Test Setup

Figure 3-1 shows a typical test setup for charging the USB Type-C device. Connect VIN+ to the power supply. Connect the USB Type-C device to the J1 and J3 connector.

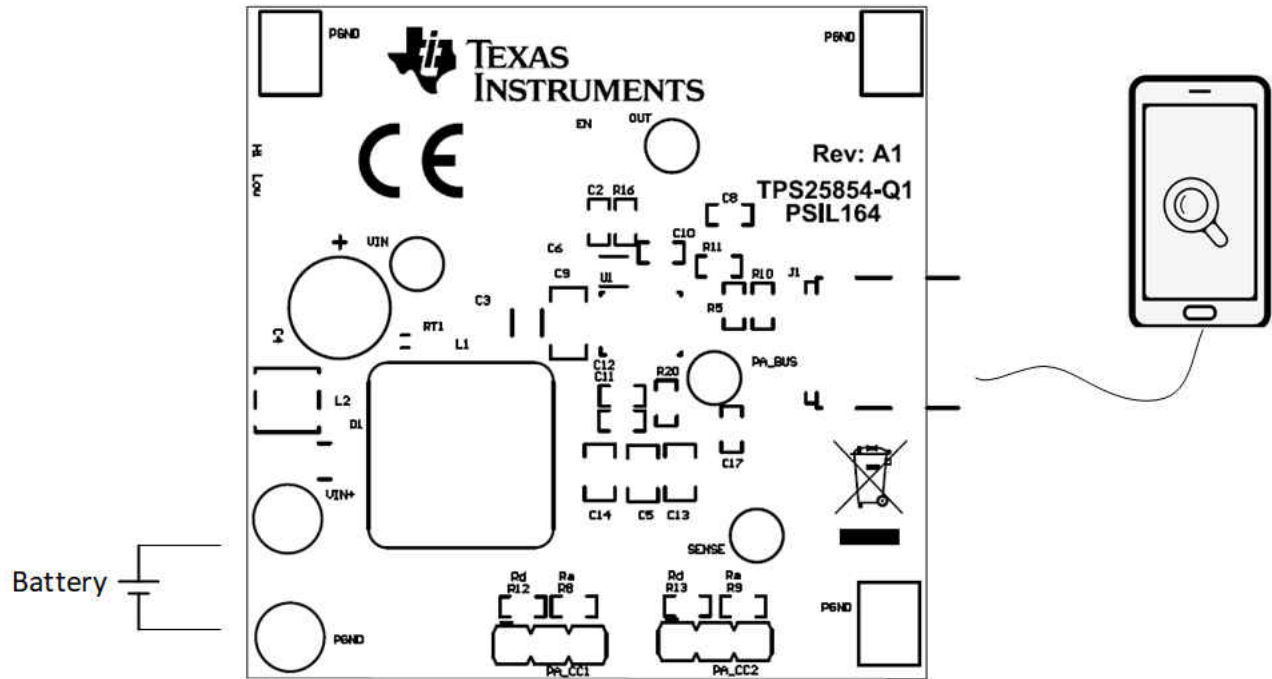


Figure 3-1. EVM Setup for Charging USB Type-C® Device

4 Board Layout

Figure 4-1 and Figure 4-2 show the top and bottom assembly. Figure 4-3 and Figure 4-4 show the top side and bottom side 3D view. Figure 4-5 through Figure 4-8 show the layout images of the EVM.

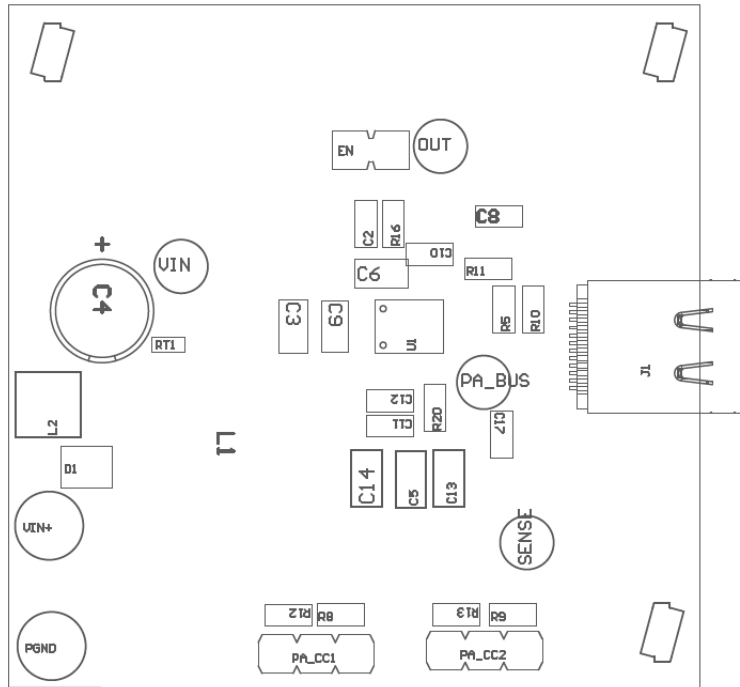


Figure 4-1. Top Side Assembly

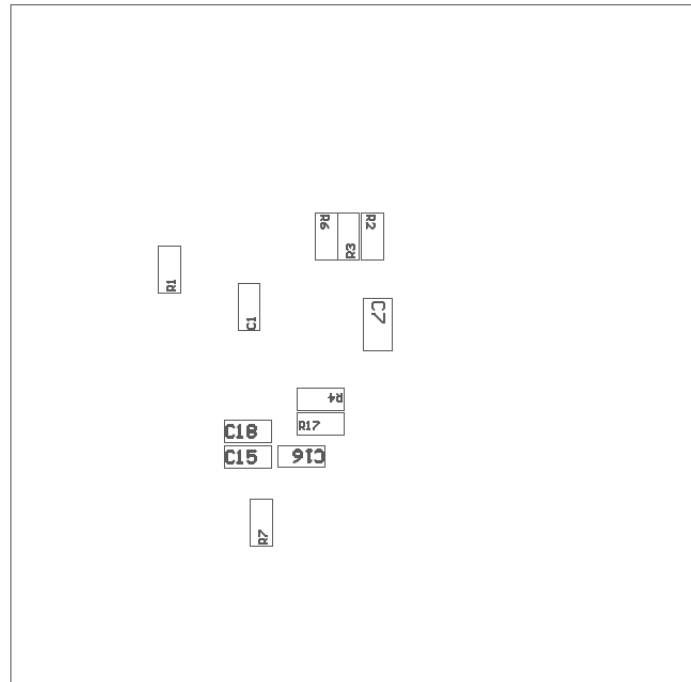


Figure 4-2. Bottom Side Assembly

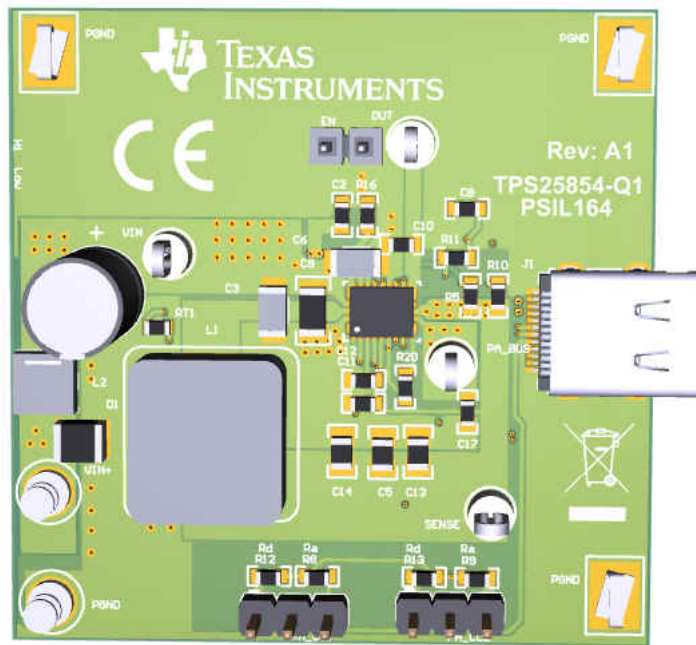


Figure 4-3. Top Side 3D View

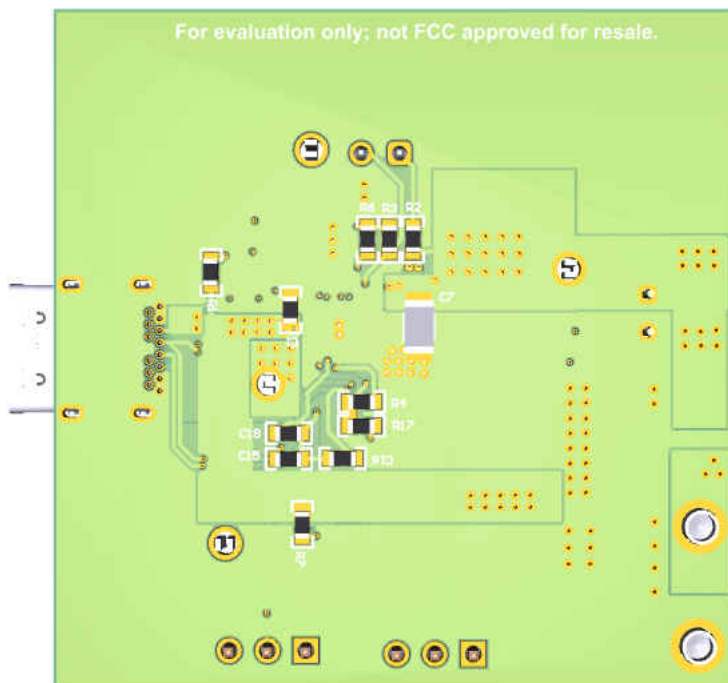


Figure 4-4. Bottom Side 3D View

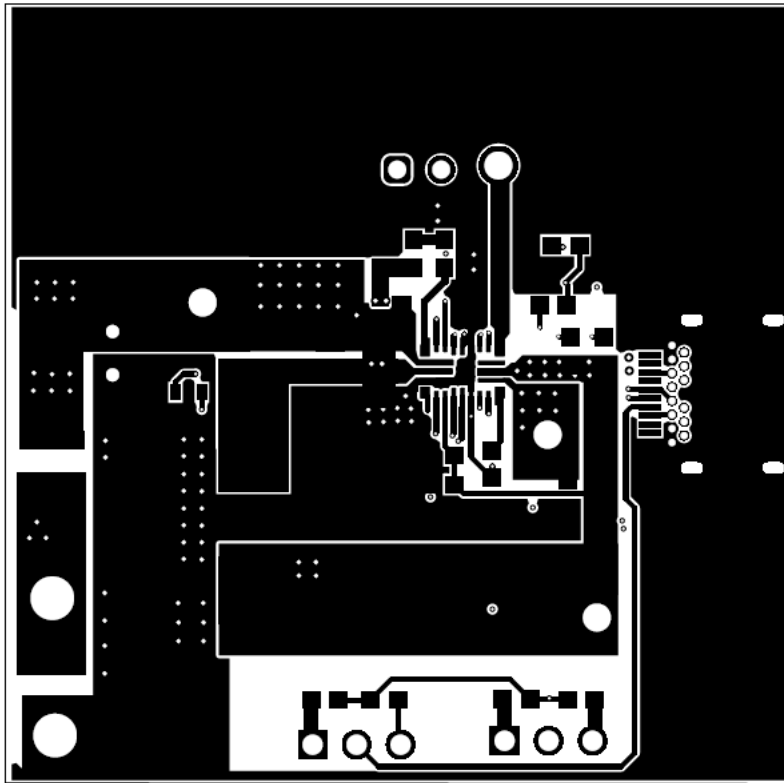


Figure 4-5. Top Layer Layout

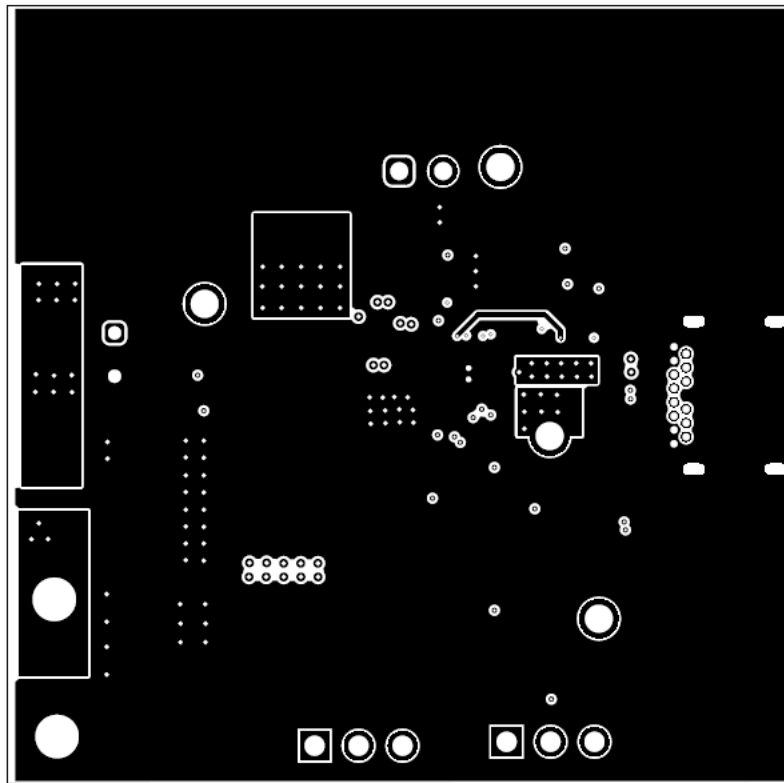


Figure 4-6. Mid-1 Layer Layout

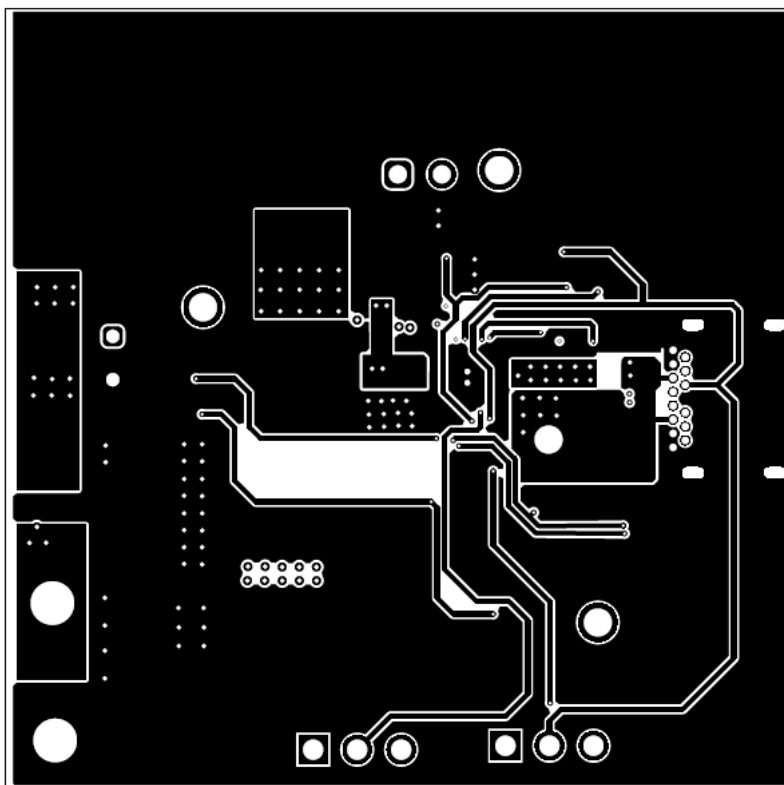


Figure 4-7. Mid-2 Layer Layout

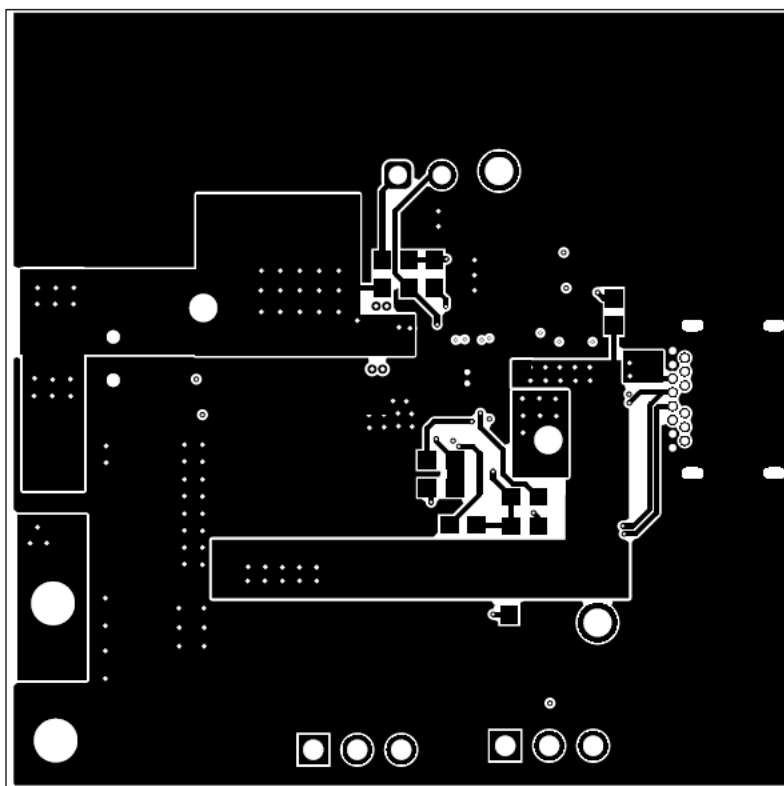


Figure 4-8. Bottom Layer Layout

5 Bill of Materials

Table 5-1 lists the EVM bill of materials.

Table 5-1. Bill of Materials

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer
C1, C2, C8, C12, C15, C16, C18	7	0.1uF	CAP, CERM, 0.1 μ F, 50 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0603	0603	C0603C104K5RACAUTO	Kemet
C3, C6, C7	3	10uF	CAP, CERM, 10 μ F, 50 V, +/- 10%, X5R, AEC-Q200 Grade 1, 1206	1206	GRT31CR61H106KE01L	MuRata
C4	1	100uF	CAP, AL, 100 μ F, 35 V, +/- 20%, TH	D6.3xL11mm	35ZLJ100M6.3X11	Rubycon
C5, C13, C14	3	22uF	CAP, CERM, 22 μ F, 10 V, +/- 20%, X7R, 0805	0805	GRM21BZ71A226ME15L	MuRata
C9	1	0.1uF	CAP, CERM, 0.1 μ F, 50 V, +/- 10%, X7R, 1206	1206	12065C104KAT2A	AVX
C10, C11	2	2.2uF	CAP, CERM, 2.2 μ F, 16 V, +/- 20%, X5R, 0603	0603	885012106018	Würth Elektronik
C17	1	1uF	CAP, CERM, 1 μ F, 6.3 V, +/- 10%, X7R, 0603	0603	CL10B105KQ8NNNC	Samsung Electro-Mechanics
D1	1	10uF	CAP, CERM, 10 μ F, 50 V, +/- 20%, X7R, 1210	1210	GRM32ER71H106MA12	MuRata
EN	1		Header, 2.54 mm, 2x1, Tin, TH	Header, 2.54 mm, 2x1, TH	TSW-102-07-T-S	Samtec
J1	1		Connector, Receptacle, USB Type C, R/A	Connector, Receptacle, USB Type C, R/A, THT/SMT	632723300011	Würth Elektronik
L1	1	3.3uH	Inductor, Shielded Drum Core, Superflux, 3.3 μ H, 12 A, 0.0059 ohm, SMD	WE-HC6	744325330	Würth Elektronik
L2	1	1uH	Inductor, Shielded, Composite, 1 μ H, 8.75 A, 0.01 ohm, SMD	4x2.1x4mm	XAL4020-102MEB	Coilcraft
NT1, PGND, U1	5			eg: 0603, used in PnP report	Used in BOM report	Used in BOM report
OUT, PA_BUS, SENSE, VIN	4		Test Point, Multipurpose, White, TH	White Multipurpose Testpoint	5012	Keystone

Table 5-1. Bill of Materials (continued)

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer
PA_CC1, PA_CC2	2		Header, 2.54 mm, 3x1, Gold, TH	Header, 2.54mm, 3x1, TH	61300311121	Würth Elektronik
PGND, VIN+	2		Terminal, Turret, TH, Double	Keystone1502-2	1502-2	Keystone
R1, R5, R10, R17	4	100k	RES, 100 k, 1%, 0.1 W, 0603	0603	CRCW0603100KFKEA	Vishay-Dale
R2	1	20k	RES, 20 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060320K0JNEA	Vishay-Dale
R3, R11, R12, R13	4	5.1k	RES, 5.1 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06035K10JNEA	Vishay-Dale
R4	1	15.0k	RES, 15.0 k, 0.5%, 0.1 W, 0603	0603	RT0603DRE0715KL	Yageo America
R6	1	49.9k	RES, 49.9 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	ERJ-3EKF4992V	Panasonic
R7	1	5.10k	RES, 5.10 k, 1%, 0.1 W, 0603	0603	RC0603FR-075K1L	Yageo America
R8, R9	2	1.0k	RES, 1.0 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06031K00JNEA	Vishay-Dale
R16, R20	2	0	RES, 0, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	RMCF0603ZT0R00	Stackpole Electronics Inc
RT1	1	470k	Thermistor NTC, 470k ohm, 3%, 0603	0603	NCP18WM474E03RB	MuRata

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